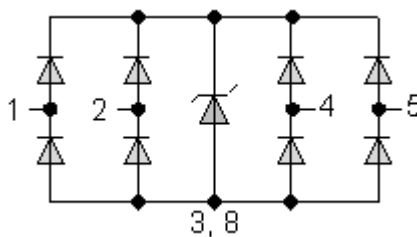
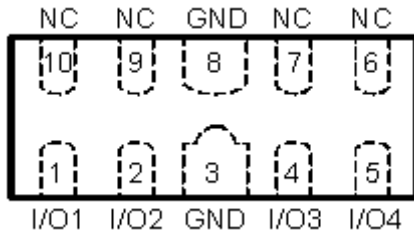
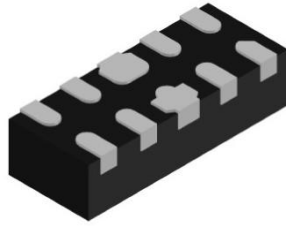


## 4-Line, Uni-directional, Transient Voltage Suppressor



**DFN2510-10L**

### Features

- Ultra small package
- Stand-off voltage: 3.3V Max
- Transient protection for each line according to IEC61000-4-2(ESD):  $\pm 12\text{kV}$  (contact)
- IEC61000-4-5(surge): 6A (8/20 $\mu\text{s}$ )
- Ultra-low capacitance:  $C_J = 0.5\text{ pF}$  typ
- Low leakage current
- Low clamping voltage
- RoHS Compliant

### Applications

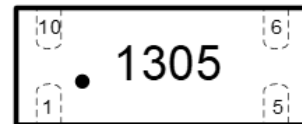
- USB 2.0 and USB 3.0
- HDMI 1.3, HDMI 1.4 and HDMI 2.0
- SATA and eSATA interface
- DVI
- IEEE 1394
- Portable Electronics and Notebooks
- Ethernet port: 10/100/1000 Mbs/s
- Desktop and Notebooks PCS

#### Caution:

*This Device is designed for signal line protection only.  
Do not operate under electrical bias or connect to a power line.*

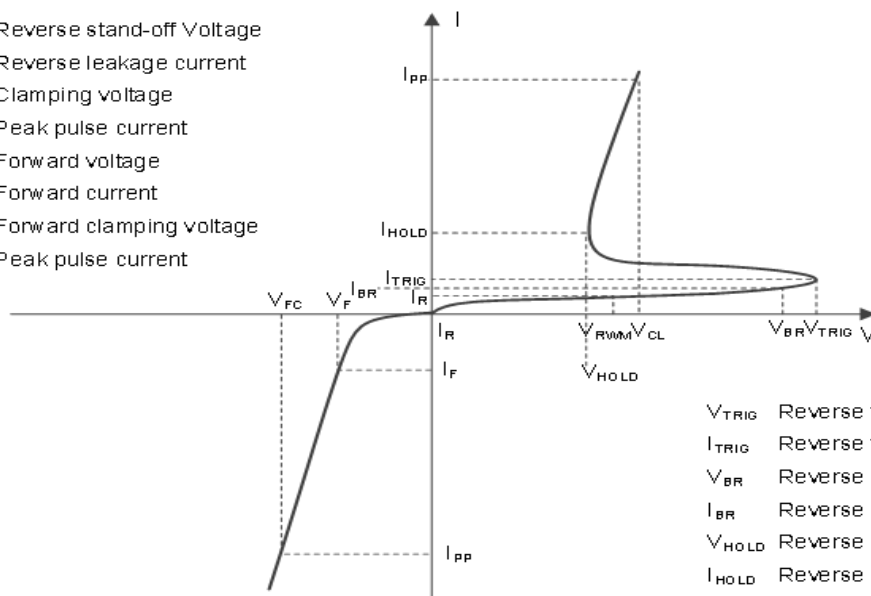
### Mechanical Characteristics

- Package: DFN2510-10L
- Case Material: "Green" Molding Compound.
- Marking Information: See Below



### Definitions of electrical characteristics

- $V_{RWM}$  Reverse stand-off Voltage
- $I_R$  Reverse leakage current
- $V_{CL}$  Clamping voltage
- $I_{PP}$  Peak pulse current
- $V_F$  Forward voltage
- $I_F$  Forward current
- $V_{FC}$  Forward clamping voltage
- $I_{PP}$  Peak pulse current



- $V_{TRIG}$  Reverse trigger voltage
- $I_{TRIG}$  Reverse trigger current
- $V_{BR}$  Reverse breakdown voltage
- $I_{BR}$  Reverse breakdown current
- $V_{HOLD}$  Reverse holding voltage
- $I_{HOLD}$  Reverse holding current



# SESDULC1E14P5

## ■Absolute Maximum Ratings (Ta=25°C unless otherwise specified)

PARAMETER	SYMBOL	Rating	UNIT
Peak pulse power ( $t_p = 8/20\mu s$ )	$P_{pk}$	27	W
Peak pulse current ( $t_p = 8/20\mu s$ )	$I_{PP}$	6	A
ESD according to IEC61000-4-2 air discharge	$V_{ESD}$	$\pm 15$	KV
ESD according to IEC61000-4-2 contact discharge		$\pm 12$	KV
Junction temperature	$T_J$	125	°C
Operating temperature	$T_{OP}$	-40~85	°C
Storage temperature	$T_{STG}$	-55~150	°C

## ■Electrical Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	$V_{RWM}$	V				3.3
Reverse leakage current	$I_R$	nA	$V_{RWM} = 3.3V$			100
Reverse breakdown voltage	$V_{BR}$	V	$I_{BR} = 1mA$	6		
Forward voltage	$V_F$	V	$I_T = 10mA$		0.7	
Clamping voltage <sup>1)</sup>	$V_{CL}$	V	$I_{PP} = 16A, t_p = 100ns$		6.0	
Clamping voltage <sup>2)</sup>	$V_{CL}$	V	$V_{ESD} = +8kV$		6.5	
Dynamic resistance <sup>1)</sup>	$R_{DYN}$	$\Omega$			0.27	
Clamping voltage <sup>3)</sup>	$V_{CL}$	V	$I_{PP} = 1A, t_p = 8/20\mu s$		2.5	3.5
		V	$I_{PP} = 6A, t_p = 8/20\mu s$		3.5	4.5
Junction capacitance	$C_J$	pF	$V_R = 0V, f = 1MHz$ Any I/O pin to GND		0.5	0.65
		pF	$V_R = 0V, f = 1MHz$ Between any I/O pin		0.25	0.4

(1). TLP parameter:  $Z_0 = 50\Omega$ ,  $t_p = 100ns$ ,  $t_r = 2ns$ , averaging window from 60ns to 80ns.  $R_{DYN}$  is calculated from 4A to 16A.

(2). Contact discharge mode, according to IEC61000-4-2.

(3). Non-repetitive current pulse, according to IEC61000-4-5.

## ■Ordering Information (Example)

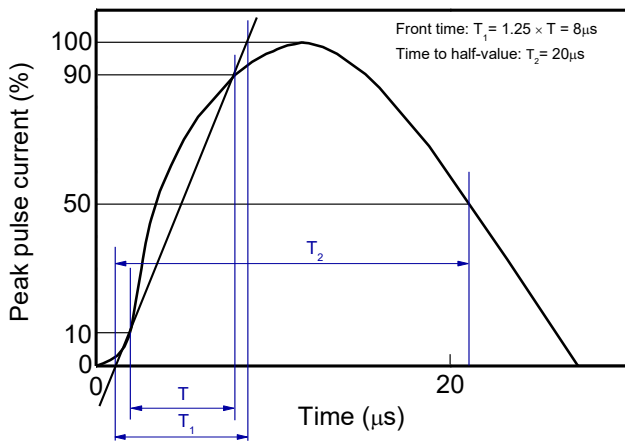
PREFERRED P/N	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SESDULC1E14P5	Approximate 4	3000	30000	120000	Tape & reel



## SESDULC1E14P5

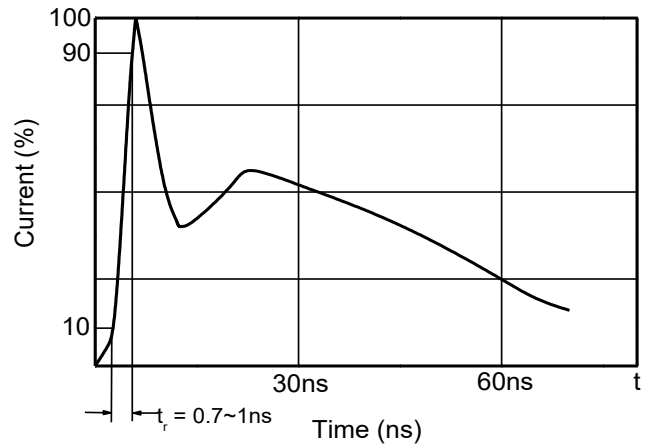
### ■ Typical Performance Characteristics (Ta=25°C unless otherwise Specified)

8/20μs waveform per IEC61000-4-5

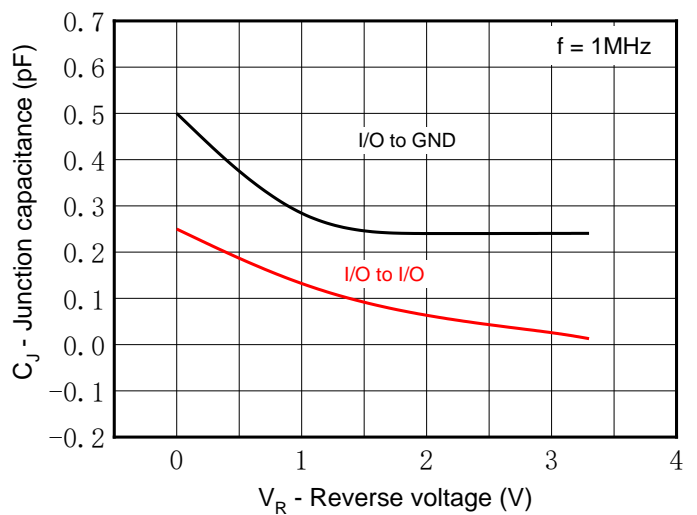
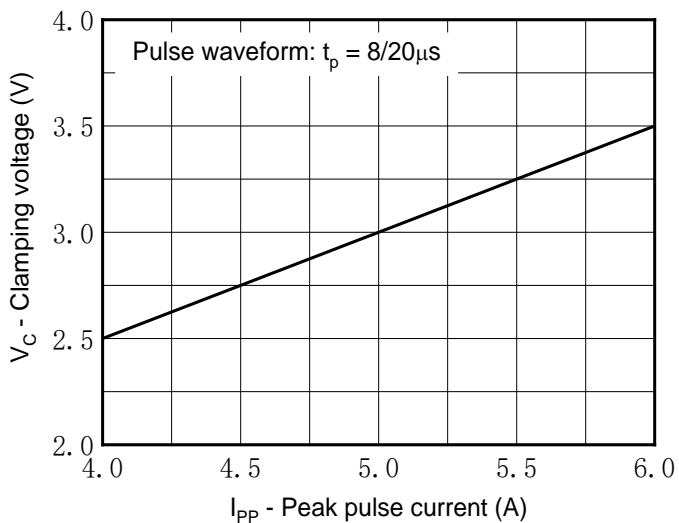


Clamping voltage vs. Peak pulse current

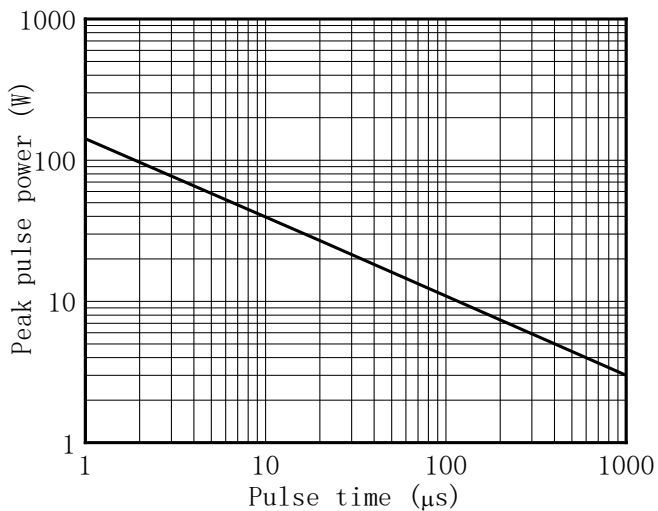
Contact discharge current waveform per IEC61000-4-2



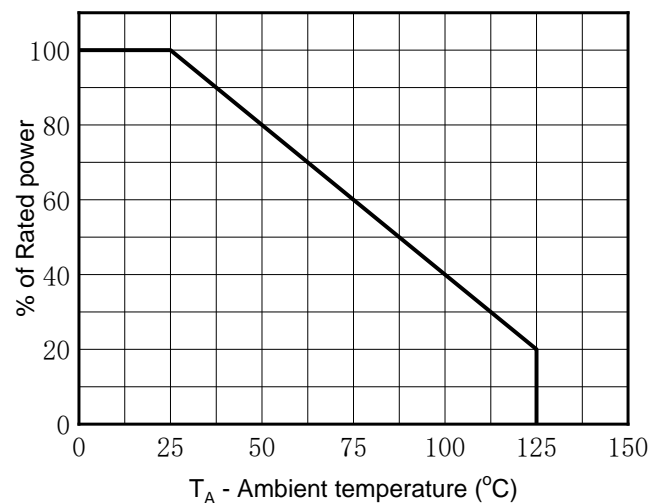
Capacitance vs. Reverse voltage



Non-repetitive peak pulse power vs. Pulse time



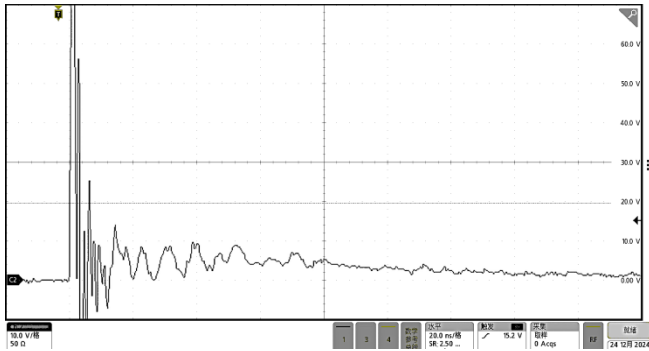
Power derating vs. Ambient temperature



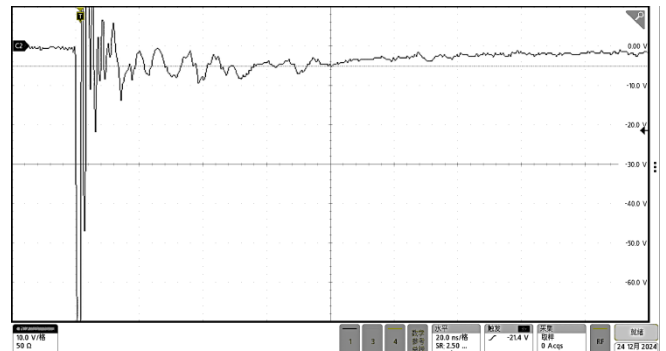


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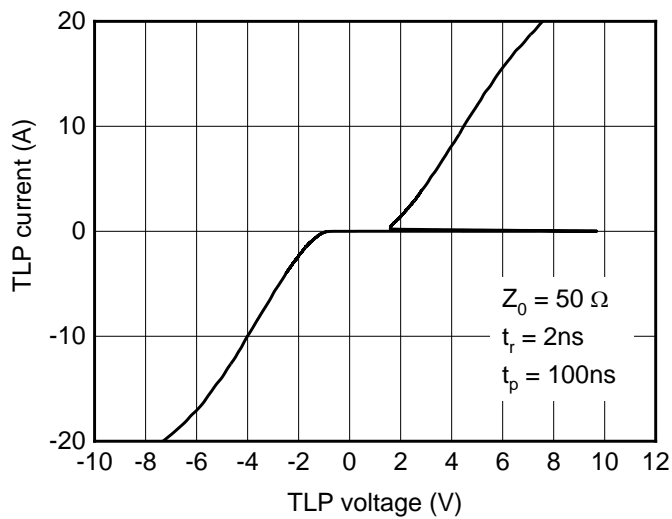
ESD clamping  
(+8kV contact discharge per IEC61000-4-2)



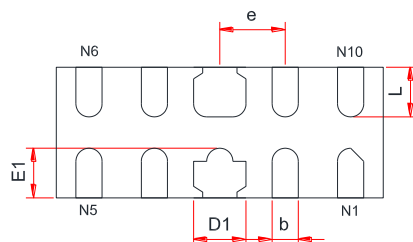
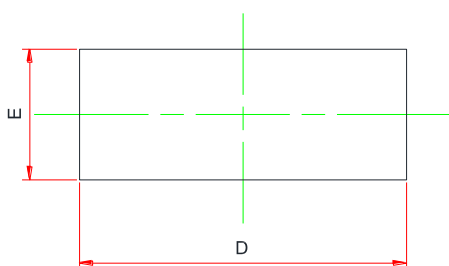
ESD clamping  
(-8kV contact discharge per IEC61000-4-2)



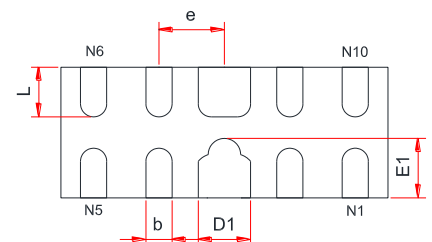
TLP Measurement



## Outline Dimensions



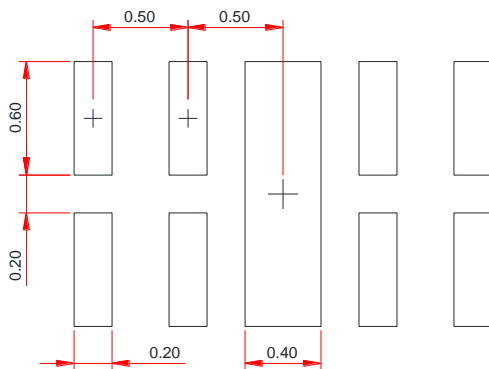
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Symbol	Dimensions in Millimeters		
	Min.	Typ.	Max.
A	0.500	0.575	0.650
A1	0.000	-	0.050
A3	0.150 Ref.		
D	2.400	2.500	2.600
E	0.900	1.000	1.100
D1	0.300	0.400	0.500
E1	0.300	0.455	0.610
b	0.130	0.190	0.250
e	0.500 BSC		
L	0.280	0.390	0.500

## ■ Recommend land pattern (Unit:mm)



### Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met



## Disclaimer

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